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Atomistic modeling of capillary-driven grain boundary motion in Cu-Ta alloys

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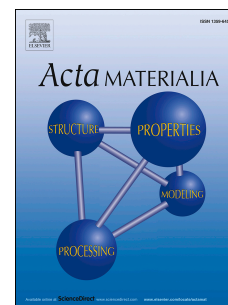
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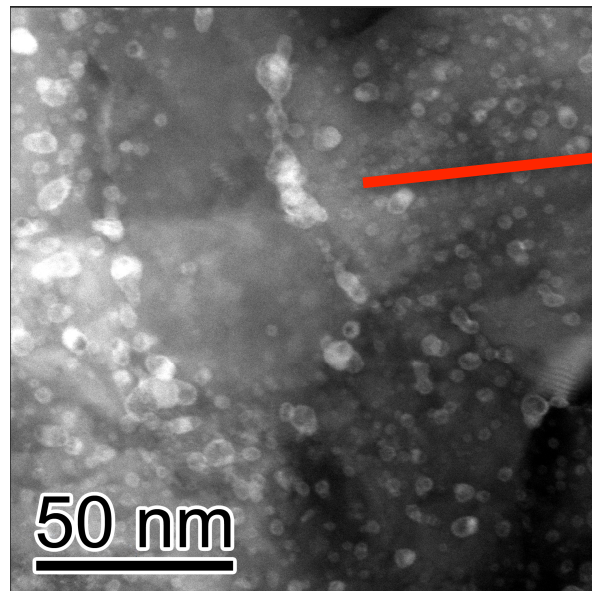
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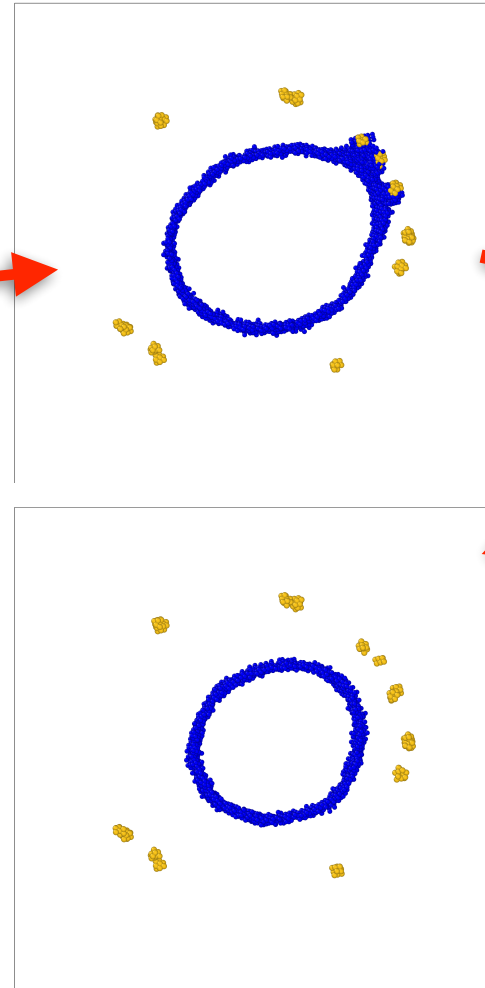
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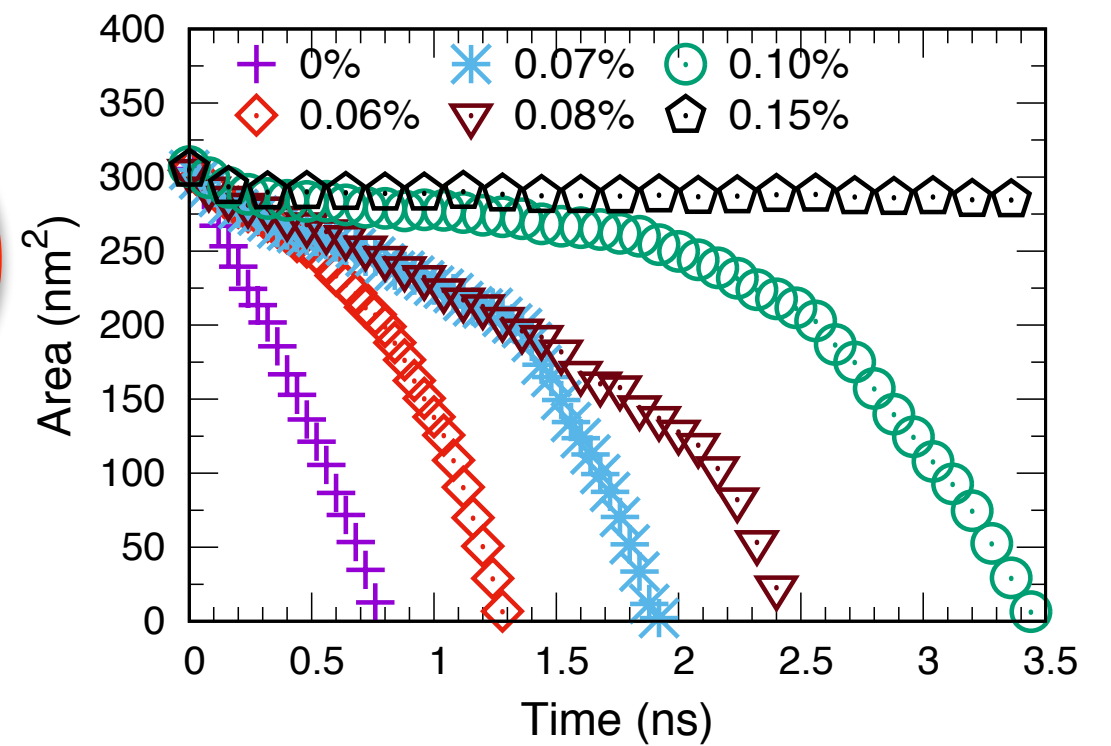
Cu-3at%Ta alloy



MD simulation



Grain boundary unpinning



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